APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

Solder Film Manufacturing Method, Heat Sink Furnished with Solder Film,

and Semiconductor-Device-and-Heat-Sink Junction

Application Type : regular, utility

Attorney Docket Number: 39.036

Correspondence address:

Customer Number: 29453

Priority Data:

Doc.No: JP-2003-126616; Country -JP; Date: 2003-05-01 us-priority-claimed

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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